

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT4785485

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
RYOTA HIURA	05/08/2017
TAKESHI FUKASE	05/08/2017
TAKUMA OKAZAKI	05/08/2017
TETSUYA ADACHI	05/08/2017
RECEIVING PARTY DATA	
Name:	MITSUBISHI HEAVY INDUSTRIES, LTD.
Street Address:	16-5, KONAN 2-CHOME, MINATO-KU
City:	TOKYO
State/Country:	JAPAN
Postal Code:	108-8215
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15543565
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	SHP-153
NAME OF SUBMITTER:	BENJAMIN J. HAUPTMAN
SIGNATURE:	/Benjamin J. Hauptman/
DATE SIGNED:	01/22/2018
Total Attachments: 3	
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ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- 1) Ryota HIURA
- 2) Takeshi FUKASE
- 3) Takuma OKAZAKI
- 4) Tetsuya ADACHI

who has made a certain new and useful invention, hereby sells, assigns and transfers unto MITSUBISHI HEAVY INDUSTRIES, LTD. having a place of business at 16-5, Konan 2-chome, Minato-ku, Tokyo 108-8215 Japan, its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled:

SYSTEM FOR EVALUATING MONITORING PLAN, AND METHOD FOR EVALUATING MONITORING PLAN

- (a) for which an application for United States Letters Patent was filed on _____, and identified by United States Patent Application No. _____; or
- (b) for which an application for United States Letters Patent was executed on _____,

and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefore and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature:

1) Ryota Hiura
Name: Ryota HIURA

May 8, 2017
Date

2) _____
Name: Takeshi FUKASE

Date

3) _____
Name: Takuma OKAZAKI

Date

Docket No.:

4) Tetsuya Adachi
Name: Tetsuya ADACHI

May 8, 2017
Date

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- 1) Ryota HIURA
- 2) Takeshi-FUKASE
- 3) Takuma OKAZAKI
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SIGNED on the date indicated aside my signature:

1) _____
Name: Ryota HIURA

Date

2) Takeshi Fukase
Name: Takeshi FUKASE

May 8, 2017
Date

3) Takuma Okazaki
Name: Takuma OKAZAKI

May 8, 2017
Date